Low-power configurable multiple function gate Rev. 7 — 17 September 2015 P

Product data sheet

General description 1.

The 74AUP1G58 provides configurable multiple functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions AND, OR, NAND, NOR, XOR, inverter and buffer. All inputs can be connected to $V_{\mbox{CC}}$ or GND.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74AUP1G58 has Schmitt trigger inputs making it capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H.

Features and benefits 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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3. Ordering information

Table 1.Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74AUP1G58GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363				
74AUP1G58GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				
74AUP1G58GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891				
74AUP1G58GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115				
74AUP1G58GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202				
74AUP1G58GX	–40 °C to +125 °C	X2SON6	plastic thermal extremely thin small outline package; no leads; 6 terminals; body 1 \times 0.8 \times 0.35 mm	SOT1255				

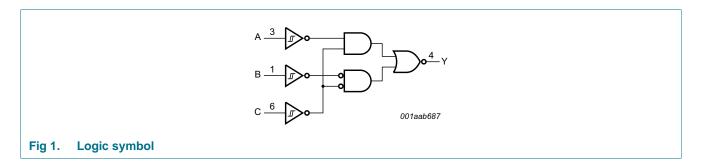
4. Marking

Table 2. Marking

Type number	Marking code ^[1]
74AUP1G58GW	аК
74AUP1G58GM	аК
74AUP1G58GF	аК
74AUP1G58GN	аК
74AUP1G58GS	аК
74AUP1G58GX	аК

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

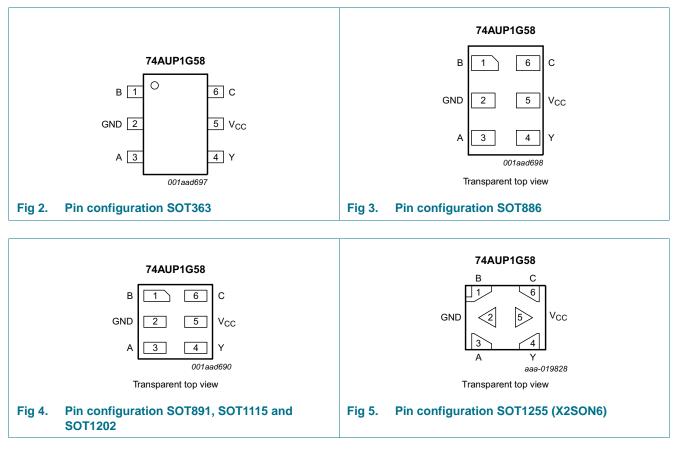
5. Functional diagram



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6. Pinning information

6.1 Pinning



6.2 Pin description

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Table 3. Pin description		
Symbol	Pin	Description
В	1	data input
GND	2	ground (0 V)
A	3	data input
Y	4	data output
V _{CC}	5	supply voltage
С	6	data input

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7. Functional description

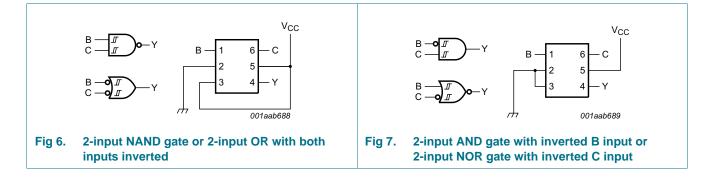
Input		Output	
С	В	Α	Y
L	L	L	L
L	L	Н	Н
L	Н	L	L
L	Н	Н	Н
Н	L	L	Н
Н	L	Н	Н
Н	Н	L	L
Н	Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

7.1 Logic configurations

Table 5.Function selection table

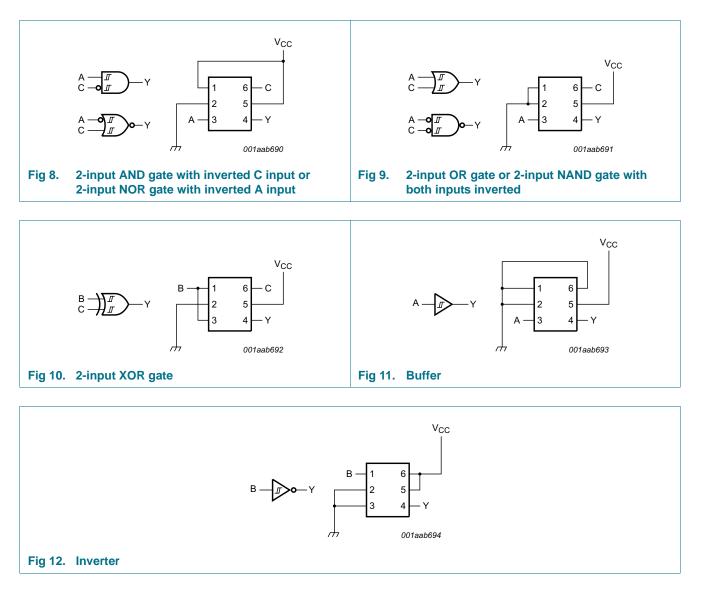
Logic function	Figure
2-input NAND	see <u>Figure 6</u>
2-input NAND with both inputs inverted	see Figure 9
2-input AND with inverted input	see <u>Figure 7</u> and <u>Figure 8</u>
2-input NOR with inverted input	see Figure 7 and Figure 8
2-input OR	see Figure 9
2-input OR with both inputs inverted	see <u>Figure 6</u>
2-input XOR	see Figure 10
Buffer	see Figure 11
Inverter	see Figure 12



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8. Limiting values

Table 6.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage	<u>[</u>	1]	-0.5	+4.6	V
Ι _{ΟΚ}	output clamping current	V _O < 0 V		-50	-	mA
Vo	output voltage	Active mode and Power-down mode	1]	-0.5	+4.6	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$		-	±20	mA
I _{CC}	supply current			-	50	mA

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Max

3.6

3.6

V_{CC}

3.6

+125

-40

Unit

V

V

V

V °C

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Limiting values ... continued Table 6.

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			-			-
Symbol	Parameter	Conditions		Min	Max	Unit
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SC-88 packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K. [2] For X2SON6 and XSON6 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

Recommended operating conditions 9.

Table 7.	Recommended operating	g conditions	
Symbol	Parameter	Conditions	Min
V _{CC}	supply voltage		0.8
VI	input voltage		0
Vo	output voltage	Active mode	0
		Power-down mode; $V_{CC} = 0 V$	0

ambient temperature

10. Static characteristics

Table 8. **Static characteristics**

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At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C				-	
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				
		I_{O} = -20 μ A; V _{CC} = 0.8 V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75\times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				_
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.31	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.31	V
		I _O = 2.3 mA; V _{CC} = 2.3 V	-	-	0.31	V
		I _O = 3.1 mA; V _{CC} = 2.3 V	-	-	0.44	V
		I_{O} = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.44	V

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Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
l _l	input leakage current	V_1 = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.1	μA
I _{OFF}	power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μΑ
ΔI_{OFF}	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.2	μΑ
I _{CC}	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μΑ
Δl _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	40	μA
CI	input capacitance	$V_1 = GND \text{ or } V_{CC}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	1.1	-	pF
Co	output capacitance	$V_O = GND; V_{CC} = 0 V$	-	1.8	-	pF
T _{amb} = -	40 °C to +85 °C					
V _{OH}	HIGH-level output voltage	$V_{I} = V_{T+} \text{ or } V_{T-}$				
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 0.8 \ \text{V} \text{ to } 3.6 \ \text{V}$	V _{CC} - 0.1	-	-	V
		I _O = -1.1 mA; V _{CC} = 1.1 V	$0.7 \times V_{CC}$	-	-	V
		I _O = -1.7 mA; V _{CC} = 1.4 V	1.03	-	-	V
		I _O = -1.9 mA; V _{CC} = 1.65 V	1.30	-	-	V
		$I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		I _O = -3.1 mA; V _{CC} = 2.3 V	1.85	-	-	V
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
V _{OL}	LOW-level output voltage	$V_1 = V_{T+}$ or V_{T-}				
		$I_0 = 20 \ \mu\text{A}; \ V_{CC} = 0.8 \ \text{V} \text{ to } 3.6 \ \text{V}$	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 imes V_{CC}$	V
		I _O = 1.7 mA; V _{CC} = 1.4 V	-	-	0.37	V
		I _O = 1.9 mA; V _{CC} = 1.65 V	-	-	0.35	V
		I _O = 2.3 mA; V _{CC} = 2.3 V	-	-	0.33	V
		I _O = 3.1 mA; V _{CC} = 2.3 V	-	-	0.45	V
		I _O = 2.7 mA; V _{CC} = 3.0 V	-	-	0.33	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.45	V
l _l	input leakage current	$V_1 = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V; } V_{CC} = 0 \text{ V}$	-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.6	μA
I _{CC}	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.9	μA
Δl _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	50	μΑ

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Symbol Parameter Conditions Max Unit Min Тур T_{amb} = -40 °C to +125 °C $V_I = V_{T+} \text{ or } V_{T-}$ Vон HIGH-level output voltage $I_{O} = -20 \ \mu A$; $V_{CC} = 0.8 \ V$ to 3.6 V V $V_{CC} - 0.11$ -_ $0.6 \times V_{CC}$ $I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ V -- $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.93 _ V _ $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V 1.17 -- $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ V 1.77 -- $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 1.67 V -_ $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.40 V -- $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.30 V --VOL LOW-level output voltage $V_I = V_{T+} \text{ or } V_{T-}$ $I_O = 20 \ \mu\text{A}; \ V_{CC} = 0.8 \ V \ to \ 3.6 \ V$ V 0.11 - $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $0.33 \times V_{CC}$ V -- $I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ V 0.41 -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V 0.39 _ - $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.36 V -- $I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ V 0.50 -- $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ V 0.36 -- $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.50 V -- $V_{I} = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V ±0.75 I_L input leakage current μΑ -_ $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$ **I**OFF power-off leakage current --±0.75 μΑ $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ additional power-off leakage +0.75μA ΔI_{OFF} -current $V_{CC} = 0 V \text{ to } 0.2 V$ $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ supply current 1.4 Icc μΑ V_{CC} = 0.8 V to 3.6 V $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A;$ Δlcc additional supply current 75 μΑ -- $V_{CC} = 3.3 V$

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Max	Min	Мах (85 °С)	Max (125 °C)	_
C _L = 5 p	F								
t _{pd}	propagation delay	A, B and C to Y; [2] see Figure 13							
		$V_{CC} = 0.8 V$	-	22.8	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	2.8	6.6	12.9	2.6	13.1	13.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	2.4	4.8	7.6	2.4	8.3	8.6	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.1	4.0	6.3	2.0	6.9	7.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.0	3.2	4.6	1.8	5.1	5.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.9	2.9	3.9	1.6	4.2	4.4	ns
C _L = 10	pF							•	
t _{pd} propagation delay	propagation delay	A, B and C to Y; [2] see Figure 13							
		$V_{CC} = 0.8 V$	-	26.4	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	3.2	7.4	14.5	3.0	14.9	15.2	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	2.7	5.4	8.7	2.7	9.4	9.8	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	2.5	4.5	7.1	2.3	7.9	8.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.4	3.8	5.3	2.2	5.9	6.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.3	3.5	4.6	1.9	4.9	5.1	ns
C _L = 15	pF								
t _{pd}	propagation delay	A, B and C to Y; [2] see Figure 13							
		$V_{CC} = 0.8 V$	-	29.9	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	3.6	8.3	16.1	3.3	16.7	17.0	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	3.0	5.9	9.7	3.0	10.5	11.0	ns
		V _{CC} = 1.65 V to 1.95 V	2.8	5.0	7.9	2.5	8.7	9.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2.7	4.2	5.9	2.5	6.6	6.9	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.5	3.9	5.2	2.2	5.5	5.8	ns

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Symbol	Parameter	Conditions		25 °C			–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 30 p	ρF								
pd	propagation delay	A, B and C to Y; [2] see Figure 13							
		$V_{CC} = 0.8 V$	-	38.0	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	4.5	10.5	20.8	4.1	21.9	24.1	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	3.8	7.5	12.2	3.8	13.5	14.1	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	3.4	6.3	10.0	3.1	11.2	11.9	ns
		V_{CC} = 2.3 V to 2.7 V	3.4	5.3	7.5	3.1	8.4	8.9	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	3.3	5.0	6.6	2.9	7.1	7.4	ns
C _L = 5 pl	F, 10 pF, 15 pF and	30 pF							
C _{PD}	power dissipation	$f_i = 1 \text{ MHz}; V_1 = \text{GND to } V_{\text{CC}}$ [3][4]							
	capacitance	$V_{CC} = 0.8 V$	-	2.7	-	-	-	-	pF
		V _{CC} = 1.1 V to 1.3 V	-	2.8	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	3.0	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	3.2	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.8	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	4.4	-	-	-	-	pF

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 14</u>.

[1] All typical values are measured at nominal $V_{\mbox{CC}}.$

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] All specified values are the average typical values over all stated loads.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

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12. Waveforms

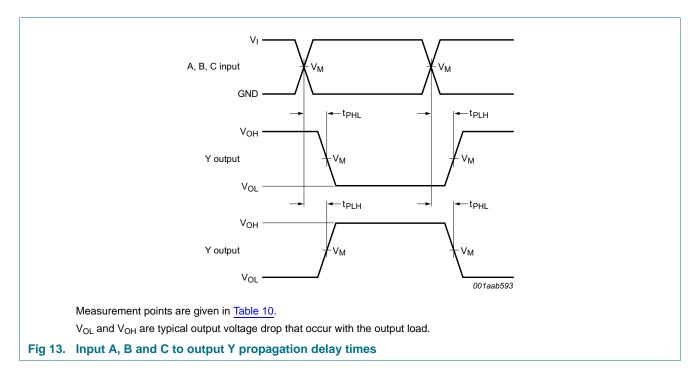


Table 10. Measurement points

Supply voltage	Output	Input			
V _{cc}	V _M	V _M	VI	t _r = t _f	
0.8 V to 3.6 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	V _{CC}	≤ 3.0 ns	

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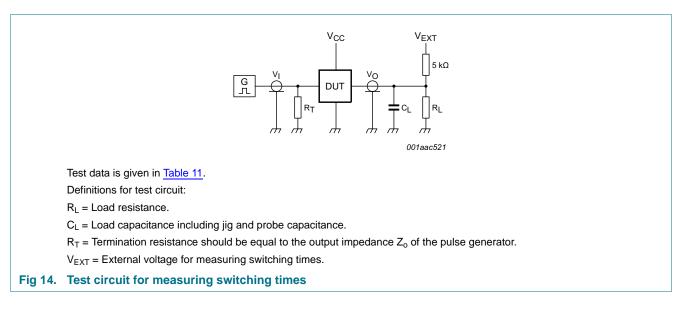


Table 11. Test data

Supply voltage	Load	V _{EXT}			
V _{cc}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times $R_L = 5 k\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 M\Omega$.

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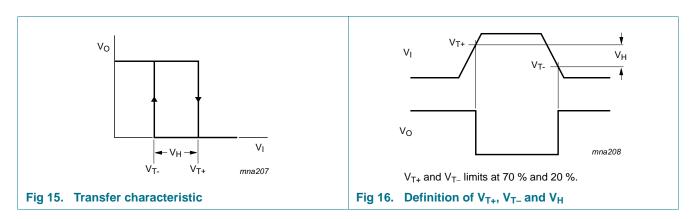
13. Transfer characteristics

Table 12. Transfer characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C		Unit	
			Min	Тур	Мах	Min	Мах (85 °С)	Max (125 °C)	
V _{T+} positive-going	see Figure 15 and Figure 16								
	threshold voltage	V _{CC} = 0.8 V	0.30	-	0.60	0.30	0.60	0.62	V
		V _{CC} = 1.1 V	0.53	-	0.90	0.53	0.90	0.92	V
		V _{CC} = 1.4 V	0.74	-	1.11	0.74	1.11	1.13	V
		V _{CC} = 1.65 V	0.91	-	1.29	0.91	1.29	1.31	V
		V _{CC} = 2.3 V	1.37	-	1.77	1.37	1.77	1.80	V
		V _{CC} = 3.0 V	1.88	-	2.29	1.88	2.29	2.32	V
V _{T-}	negative-going	see Figure 15 and Figure 16							
	threshold voltage	V _{CC} = 0.8 V	0.10	-	0.60	0.10	0.60	0.60	V
		V _{CC} = 1.1 V	0.26	-	0.65	0.26	0.65	0.65	V
		V _{CC} = 1.4 V	0.39	-	0.75	0.39	0.75	0.75	V
		V _{CC} = 1.65 V	0.47	-	0.84	0.47	0.84	0.84	V
	V _{CC} = 2.3 V	0.69	-	1.04	0.69	1.04	1.04	V	
	V _{CC} = 3.0 V	0.88	-	1.24	0.88	1.24	1.24	V	
V _H hysteresis voltag	hysteresis voltage	$(V_{T+} - V_{T-})$; see Figure 15, Figure 16, Figure 17 and Figure 18							
		V _{CC} = 0.8 V	0.07	-	0.50	0.07	0.50	0.50	V
		V _{CC} = 1.1 V	0.08	-	0.46	0.08	0.46	0.46	V
		V _{CC} = 1.4 V	0.18	-	0.56	0.18	0.56	0.56	V
		V _{CC} = 1.65 V	0.27	-	0.66	0.27	0.66	0.66	V
		V _{CC} = 2.3 V	0.53	-	0.92	0.53	0.92	0.92	V
		V _{CC} = 3.0 V	0.79	-	1.31	0.79	1.31	1.31	V

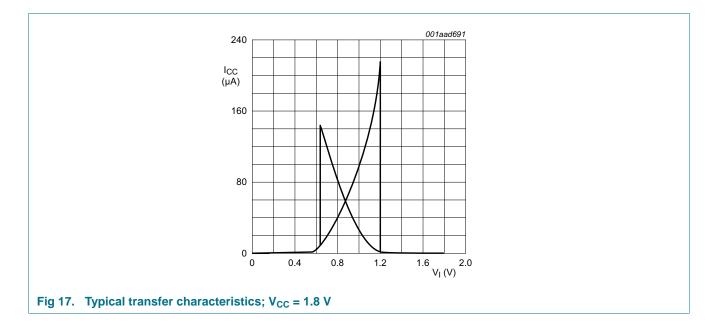
14. Waveforms transfer characteristics

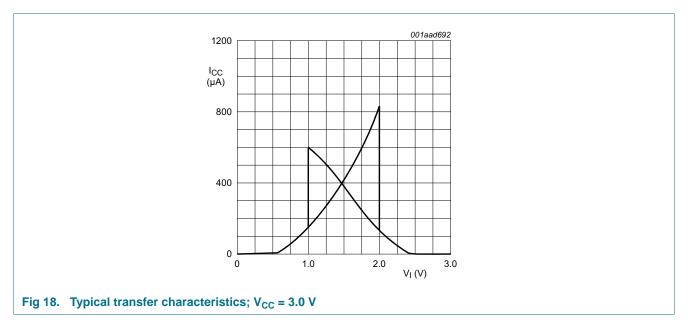


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15. Package outline

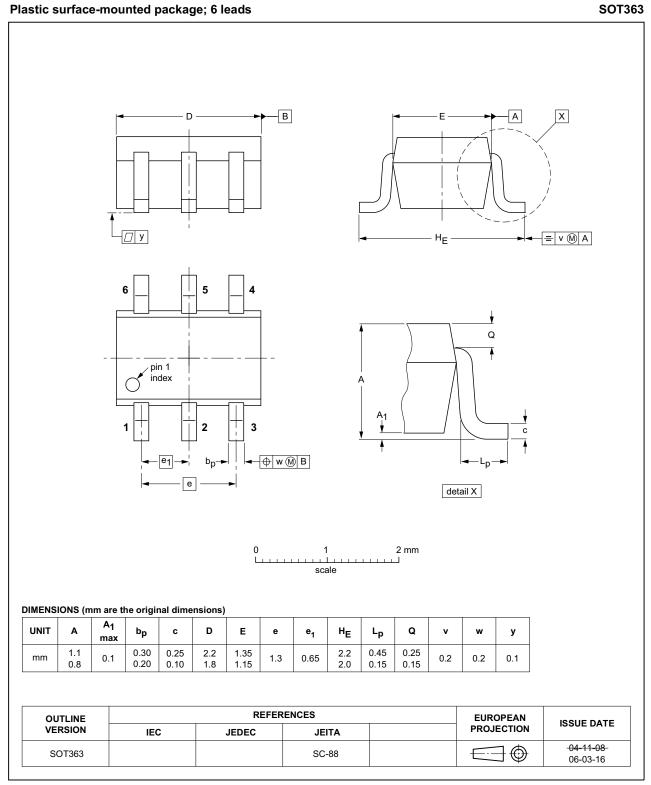


Fig 19. Package outline SOT363 (SC-88)

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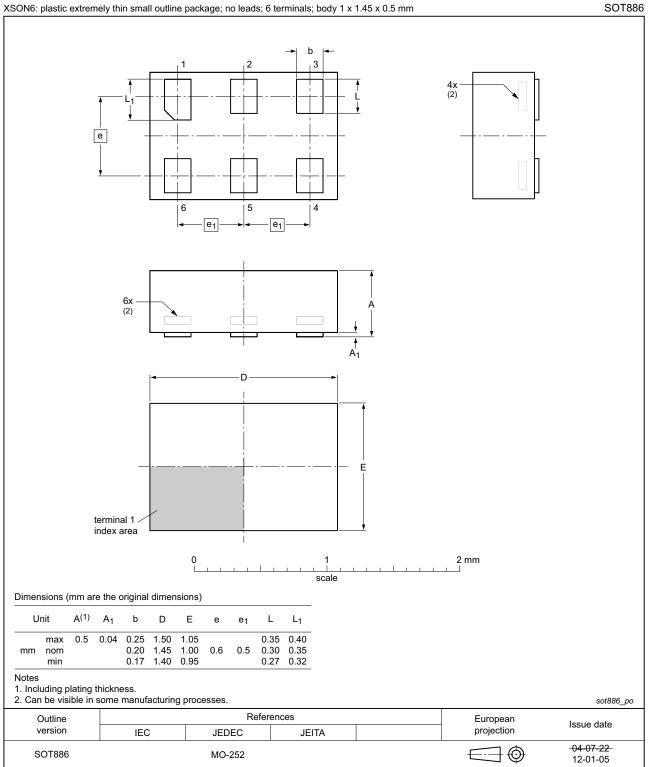


Fig 20. Package outline SOT886 (XSON6)

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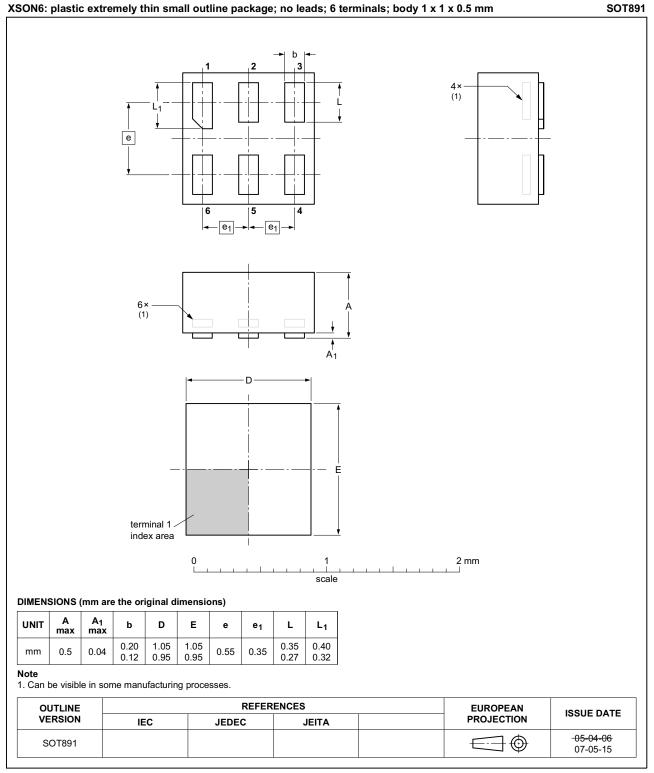
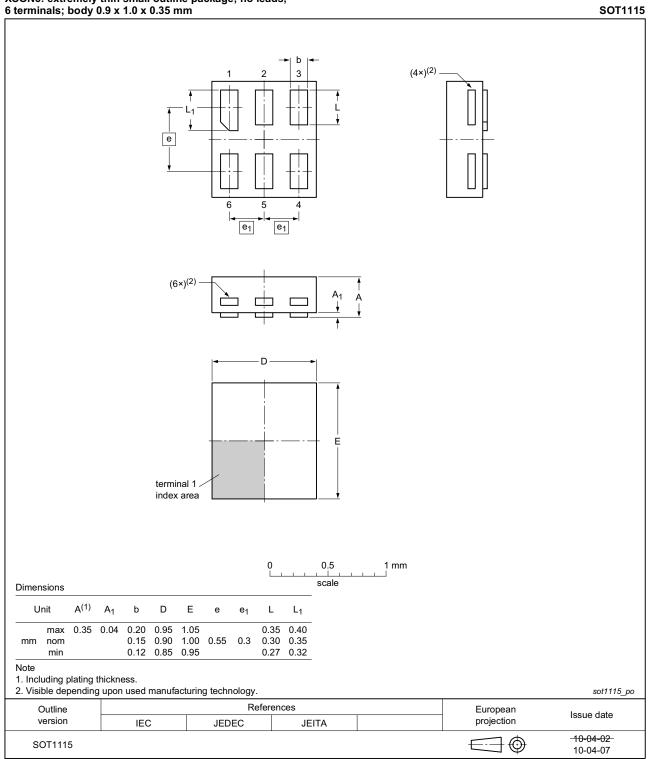


Fig 21. Package outline SOT891 (XSON6)

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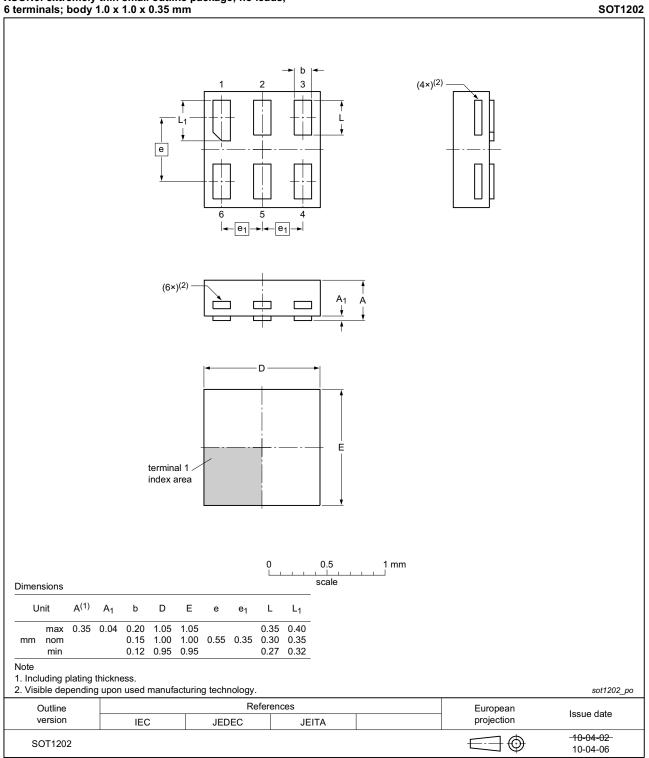


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 22. Package outline SOT1115 (XSON6)

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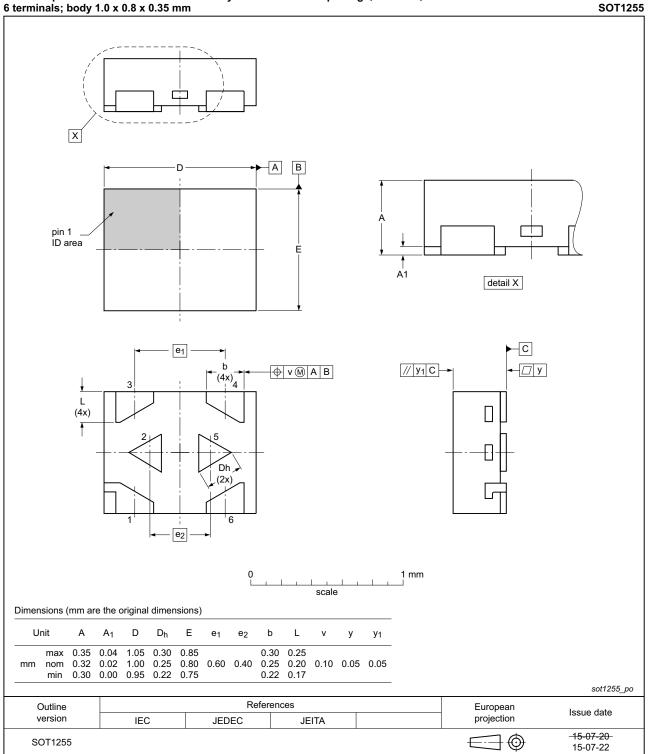


XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 23. Package outline SOT1202 (XSON6)

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X2SON6: plastic thermal enhanced extremely thin small outline package; no leads; 6 terminals; body 1.0 x 0.8 x 0.35 mm

Fig 24. Package outline SOT1255 (X2SON6)

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16. Abbreviations

Table 13. Abbreviations		
Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	

17. Revision history

Table 14.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G58 v.7	20150917	Product data sheet	-	74AUP1G58 v.6
Modifications:	 Added type nu 	Imber 74AUP1G58GX (SOT1	255/X2SON6).	
74AUP1G58 v.6	20120815	Product data sheet	-	74AUP1G58 v.5
Modifications:	 Package outling 	ne drawing of SOT886 (Figure	20) modified.	
74AUP1G58 v.5	20111129	Product data sheet	-	74AUP1G58 v.4
74AUP1G58 v.4	20101011	Product data sheet	-	74AUP1G58 v.3
74AUP1G58 v.3	20090622	Product data sheet	-	74AUP1G58 v.2
74AUP1G58 v.2	20090326	Product data sheet	-	74AUP1G58 v.1
74AUP1G58 v.1	20070131	Product data sheet	-	-

18. Legal information

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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